

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	683	438/462.ccls.	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:23
L2	4167	ablat\$3 with (substrate or wafer)	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:20
L3	323665	@ad>"20030929" or @rlad>"20030929"	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:21
L4	19	1 and 2	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:21
L5	17	4 not 3	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:21
L6	126	438/463.ccls.	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:25
L7	23	2 and 6	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:23
L8	17	7 not 3	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:24
L9	161	438/473.ccls.	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:25
L10	0	2 and 9	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:25
L11	556	438/690.ccls.	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:25
L12	17	2 and 11	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:25
L13	15	12 not 3	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:27
L14	16726	(conductive or metal) with (planarizing or planarization or cmp)	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:27
L15	96	2 and 14	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:27
L16	78	15 not 3	US-PGPUB; USPAT	OR	OFF	2005/09/16 14:27
L17	0	("2005/0070092").URPN.	USPAT	OR	OFF	2005/09/16 14:28